



PowerPC 403GA, 403GB and 403GC Embedded Controllers

Highlights

Bus Interface

- Direct-connect peripheral/ROM and DRAM interfaces
- Support for 8-, 16- and 32-bit devices
- Addressing for main memory storage:
 - 192MB (403GB)
 - 512MB (403GA and 403GC)
- External bus master support using the internal DRAM controller
- IEEE 1149.1 (JTAG) compatible interface, for test, debug and real-time trace support

DMA Controller

- Independent DMA channels:
 - Four (4) (403GA and 403GC)
 - Two (2) (403GB)
- Buffered, fly-by, memory-to-memory modes
- Programmable for 8-, 16- and 32-bit transfers
- Data chaining

Interrupt Controller

- Low latency interrupt handling (three cycles typical)
- Six external interrupt inputs (five regular, one critical)
- Dual level interrupt structure for robust debug

Instruction Fetch, Branch and Dispatch Unit

- Four instruction prefetch queue
- Branch folding and static branch prediction
- Dispatches up to two instructions per cycle

Serial Port (403GA & 403GC only)

- RS-232 serial communications
- Programmable to 1.5 Mb/s

Memory Protection

- Device protection
- Address protection

Instruction and Data Caches

- Separate 2KB instruction and 1KB data caches
- Two-way set-associative
- Fetch-thru instruction cache
- Write-back data cache

Timers

- 56-bit time base (403GA and 403GB)
- 64-bit time base (403GC)
- 32-bit programmable interval timer
- Fixed interval timer
- Watchdog timer for system error recovery

Power Management Capability

- Static low-power design
- Dynamic power management and stand-by mode
- Support 3.3V and 5V peripherals

Memory Management Unit (403GC only)

- Memory Management Unit is precache (cache tags are physical addresses)
- 8 page sizes (1K-16M by powers of 4) for efficient system memory use
- 64 entry fully associative TLB with software replacement
- 16 protection zones
- Efficiently designed to minimize die area

Product Description

PowerPC 403GA*, 403GB* and 403GC* 32-bit RISC Embedded Controllers combine high performance and functional integration with low power consumption. On-chip caches and integrated device control functions reduce system chip count and design complexity, while improving system throughput.

These embedded controllers execute programs at sustained speeds approaching one instruction per cycle. Their RISC processor cores are tightly coupled to internal 2KB instruction and 1KB data caches, reducing overhead for data transfers to and from main storage. Instruction queue logic minimizes pipeline stalls by managing branch prediction, branch folding and instruction prefetching.

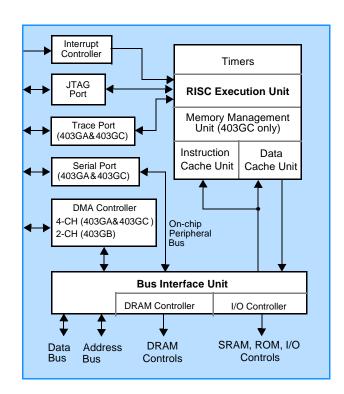
The PowerPC 403GC includes an integrated MMU featuring a fully associative TLB. Each entry provides translation for a memory page, which can be one of several sizes. TLB replacement is managed by software, which can employ the optimum replacement strategy for a particular application.

All 403 Embedded Controllers implement the PowerPC Architecture* in IBM's 0.5 μ m CMOS technology. These embedded controllers provide low-power 3.3V operation, with built-in stand-by mode and dynamic power management.



Technology	0.5 μm CMOS, 3 levels of metal
Number of Transistors	~ 585,000 (403GA), ~ 500,000 (403GB), ~ 635,000 (403GC)
Max Case Temp. Range	0°C to 85°C
Signal I/Os	126 (403GA and 403GC) 104 (403GB)
Power Supply	3.3V ±5% (support for 5V I/Os)
Performance	56 MIPS (Dhrystone2.1) @ 40MHz (403GA and 403GC) 39 MIPS (Dhrystone2.1) @ 28MHz (403GB)
Performance/Power	175 MIPS/W (Dhrystone 2.1) (403GA and 403GC) 186 MIPS/W (Dhrystone 2.1) (403GB)
Power Dissipation (typ.)	320 mW @ 40MHz (403GA and 403GC) 210 mW @ 28MHz (403GB)
Packaging	160-pin plastic quad flat pack (403GA and 403GC) 128-pin thin quad flat pack (403GB)
Frequency	25, 33 or 40MHz (403GA and 403GC) 28 MHz (403GB)

The PowerPC 403GA, 403GB and 403GC are supported by IBM and over 75 select third-party vendors in the PowerPC Embedded Tools* program. This program offers a full range of embedded development tools, including compilers, debuggers, real-time operating systems, emulators, logic analyzers, and evaluation boards.



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